NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE2301F uses advanced trench technology to provide excellent $R_{\rm DS(ON)}$, low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications.

General Features

• $V_{DS} = -20V, I_{D} = -2 A$

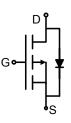
 $R_{DS(ON)}$ < 150m Ω @ V_{GS} =-2.5V

 $R_{DS(ON)}$ < 120m Ω @ V_{GS} =-4.5V

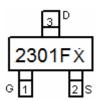
- High power and current handing capability
- Lead free product is acquired
- Surface mount package

Application

- PWM applications
- Load switch



Schematic diagram



Marking and pin assignment



SOT-23 top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
2301F X	NCE2301F	SOT-23	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	-20	V	
Gate-Source Voltage	V _{GS}	±12	V	
Drain Current-Continuous	I _D	-2.0	Α	
Drain Current -Pulsed (Note 1)	I _{DM}	-10	Α	
Maximum Power Dissipation	P _D	0.7	W	
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$	

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	178	°C/W
,	****		1

Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-20		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-20V,V _{GS} =0V	-	-	-1	μA





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Parameter	Symbol	Condition	Min	Тур	Max	Unit
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±12V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-0.4	-0.7	-1	V
Drain Course On Ctata Basistana	Б	V _{GS} =-4.5V, I _D =-2 A	-	88	120	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-2.5V, I _D =-1.8A	-	120	150	mΩ
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-2A	4	-	-	S
Dynamic Characteristics (Note4)			•	•		
Input Capacitance	C _{lss}	\/ 40\/\\ 0\/	-	285	-	PF
Output Capacitance	Coss	V_{DS} =-10V, V_{GS} =0V,	-	58	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	32	-	PF
Switching Characteristics (Note 4)			•	•		
Turn-on Delay Time	t _{d(on)}		-	9.8	-	nS
Turn-on Rise Time	t _r	V_{DD} =-10V, R_L =5 Ω	-	4.9	-	nS
Turn-Off Delay Time	Delay Time $t_{d(off)}$ V_{GS} =-4.5V, R_{GEN} =3 Ω		-	20.5	-	nS
Turn-Off Fall Time	t _f		-	7	-	nS
Total Gate Charge	Qg	\/ 40\/ L 0A	-	2.9	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-10V,I _D =-2A,	-	0.45	-	nC
Gate-Drain Charge	Q_{gd}	V_{GS} =-4.5 V	-	0.75	-	nC
Drain-Source Diode Characteristics	,			•		•
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-2A	-	-	-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-2.0	Α

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production



Pb Free Product

Typical Electrical and Thermal Characteristics

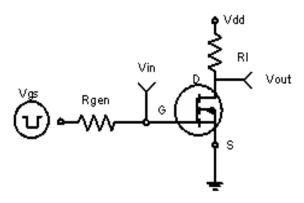


Figure 1:Switching Test Circuit

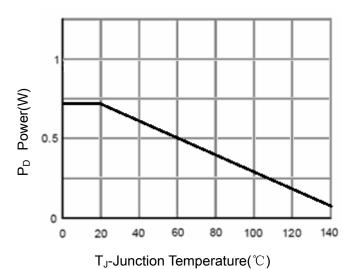


Figure 3 Power Dissipation

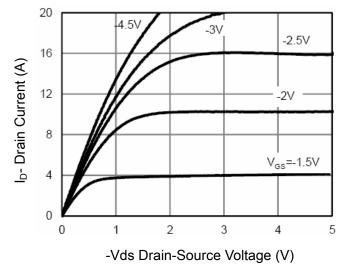


Figure 5 Output Characteristics

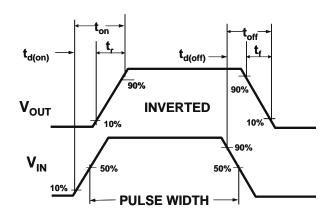


Figure 2:Switching Waveforms

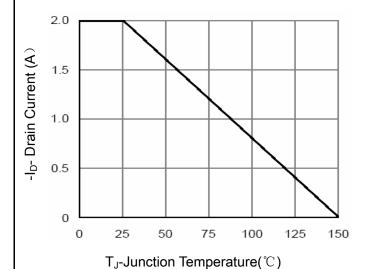


Figure 4 Drain Current

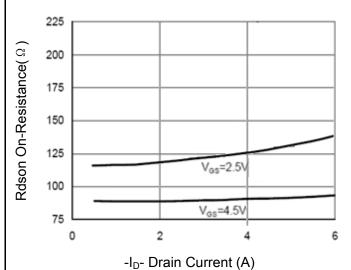


Figure 6 Drain-Source On-Resistance



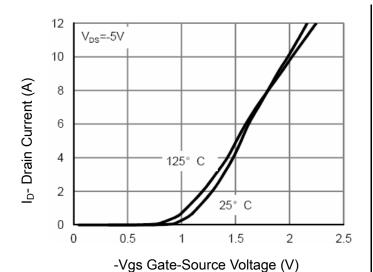


Figure 7 Transfer Characteristics

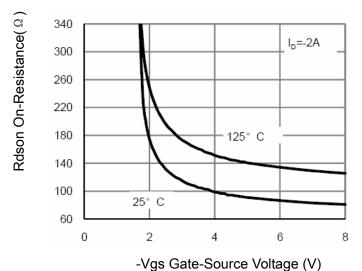


Figure 9 Rdson vs Vgs

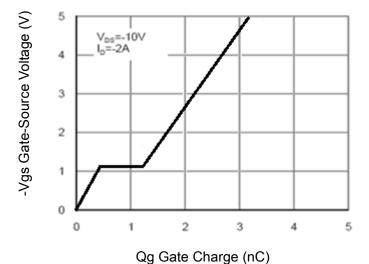
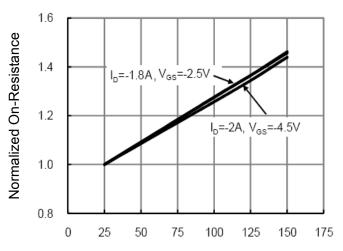


Figure 11 Gate Charge



 T_J -Junction Temperature(${}^{\circ}$ C) Figure 8 Drain-Source On-Resistance

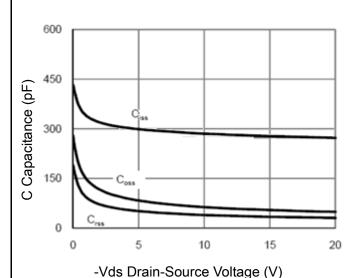


Figure 10 Capacitance vs Vds

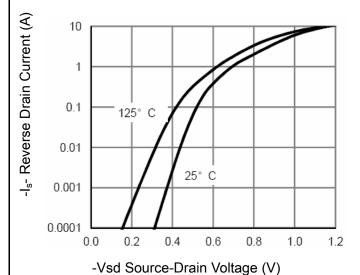
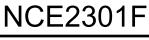


Figure 12 Source- Drain Diode Forward

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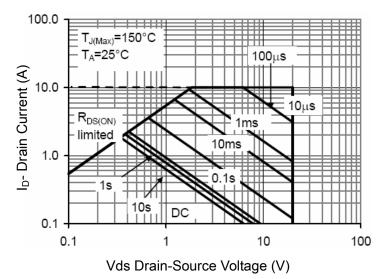


Figure 13 Safe Operation Area

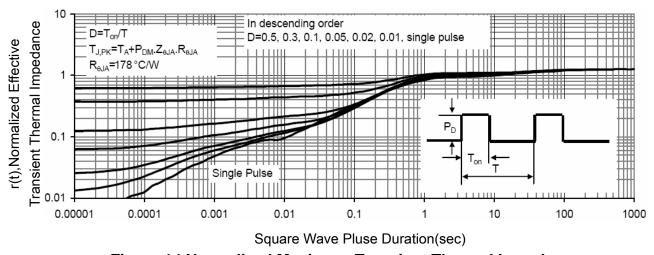
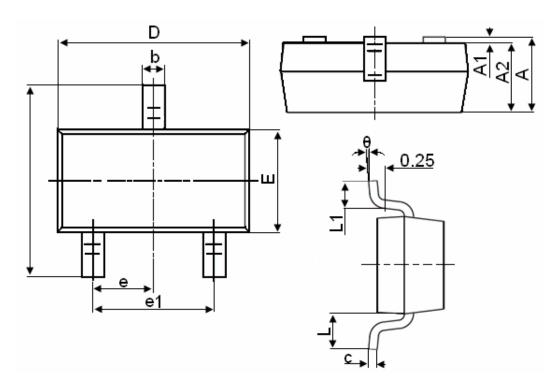


Figure 14 Normalized Maximum Transient Thermal Impedance



SOT-23 Package Information



Symbol	Dimensions in Millimeters			
Symbol	MIN.	MAX.		
Α	0.900	1.150		
A1	0.000	0.100		
A2	0.900	1.050		
b	0.300	0.500		
С	0.080	0.150		
D	2.800	3.000		
Е	1.200	1.400		
E1	2.250	2.550		
e 0.950TYP		0.950TYP		
e1	1.800	2.000		
L	0.550REF			
L1	0.300	0.500		
θ	0°	8°		

Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance ±0.10mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- $5. \ Controlling \ dimension \ is \ millimeter, \ converted \ inch \ dimensions \ are \ not \ necessarily \ exact.$



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